

EV2678EG-00A

Single-Cell, Li-Ion Battery Charger **Protection Circuit with Low-Dropout Mode Evaluation Board**

The Future of Analog IC Technology

DESCRIPTION

The EV2678EG-00A is an evaluation board designed to demonstrate the capabilities of the MP2678, a high-performance, single-cell Li-ion and Li-polymer battery charger protection circuit with low-dropout mode. Its regulated 5V output is maintained at input voltages up to the overvoltage protection (OVP) threshold (10.4V).

The device operates similar to a linear regulator, and provides fault indication to indicate when a fault event occurs (e.g. an input over-voltage [OV] event, battery OV event, or over-current event).

Full protection features include input OVP, battery OVP, and over-current protection (OCP). MP2678 also monitors its internal temperature and provides over-temperature protection (OTP).

MP2678 is available in QFN-8 (2mmx2mm) package.

ELECTRICAL SPECIFICATIONS

Parameter	Symbol	Value	Units
Input voltage	Vin	6	V
Input over voltage protection	V _{OVP}	10.4	V
Limit current	I _{LIM}	1.5	Α

FEATURES

- Input Surge Up to 30V
- 5V Regulated Output
- Input Over Voltage Protection (OVP)
- MPS Proprietary Battery OVP
- Output Short-Circuit Protection (SCP)
- Soft-Stop to Prevent Voltage Spikes
- Up to 1.7A Load Current
- Thermal Monitoring
- Thermal Shutdown
- Enable (EN) Function
- **Fault Indication**

APPLICATIONS

- Cell Phones
- **Smartphones**
- Personal Digital Assistants (PDAs)
- MP3 Players
- **Digital Cameras**
- Low-Power Handheld Devices

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7/9/2021



EV2678EG-00A EVALUATION BOARD



LxWxH (2.7cmx2.6cmx1.1cm)

Board Number	MPS IC Number
EV2678EG-00A	MP2678EG



QUICK START GUIDE

This evaluation board is designed to evaluate the MP2678EG. The board layout accommodates most commonly used capacitors and resistors.

- 1. Preset the power supply to 2.6V, then turn off the power supply.
- 2. Connect the output terminals to:
 - a. Positive (+): VOUT
 - b. Negative (-): GND
- 3. Connect the input (30V max) terminals to:
 - a. Positive (+): VIN
 - b. Negative (-): GND
- 4. After making the connections, turn on the power supply.
- 5. Drive the VIN pin above 2.6V to turn the board on; drive VIN below 2.4V to turn it off.
- 6. If the input voltage (V_{IN}) exceeds 10.4V, then an input OVP is triggered, and the connection between the VIN and VOUT pins is disconnected.
- The VBATT pin monitors the battery voltage to detect any over-voltage events. If VBATT's voltage (V_{BATT}) exceeds 4.35V, battery OVP is triggered, and the connection between the VIN and VOUT pins is disconnected.
- 8. The VB resistor (R_{VB}) limits the sink current to the IC. It is recommended that R_{VB} between 200k Ω and 1M Ω .
- 9. The IC's current limit is set internally to 1.5A. If the input current (I_{IN}) exceeds 1.5A, then over-current protection (OCP) is triggered, and VOUT's voltage (V_{OUT}) drops to 0V.
- 10. An over-temperature (OT) fault may occur during a large power loss, which results in a large difference between V_{IN} and V_{OUT}. For example, if V_{IN} = 7V, V_{OUT} = 5V, I_{IN} = I_{OUT} = 1A, then the power loss difference can be calculated with Equation (1):

$$P_{LOSS} = (V_{IN} - V_{OUT}) \times I_{IN}$$
 (1)

For a QFN-8 (2mmx2mm) package, θ_{JA} is 80°C/W. 2W of power are dissipated when 1A of I_{IN} flows through the IC while V_{IN} is 7V and V_{OUT} is 5V. This produces a rise in the die temperature for 2W x 80°C / W = 160°C. The sum of the 160°C and room temperature (e.g. 25°C) exceeds the thermal shutdown threshold (typically 140°C), therefore causing an over-temperature (OT) fault.

11. If a fault event occurs, the \overline{FLT} pin goes low.



EVALUATION BOARD SCHEMATIC

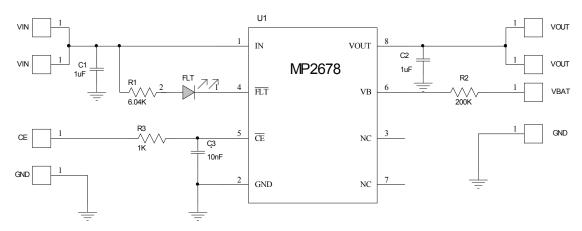


Figure 1: Evaluation Board Schematic





EV2678EG-00A BILL OF MATERIALS

Qty	Ref	Value	Description	Package	Manufacturer	Manufacturer P/N
2	C1, C2	1µF	Ceramic capacitor, 50V, X7R	0805	Murata	GRM21BR71H105KA12L
1	C3	10nF	Ceramic capacitor, 50V, X7R	0603	Murata	GRM188R71H103KA01D
1	R1	6.04kΩ	Film resistor, 1%	0603	Yageo	RC0603FR-076K04L
1	R2	200kΩ	Film resistor, 5%	0603	Yageo	RC0603JR-07200KL
1	R3	1kΩ	Film resistor, 1%	0603	Yageo	RC0603FR-071KL
1	FLT	Red	Red LED	0805	Bright LED	BL-HUF35A-TRB
1	U1	MP2678	Li-ion battery charger protection IC with low-dropout mode	QFN-8 (2mmx 2mm)	MPS	MP2678EG



PCB LAYOUT

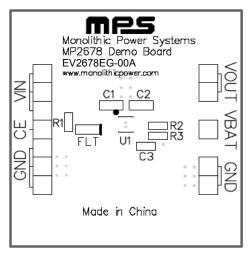


Figure 2: Top Silk

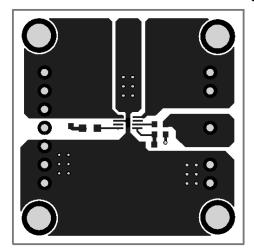


Figure 3: Top Layer

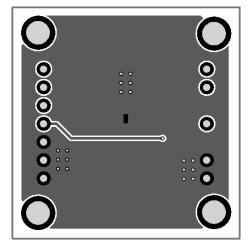


Figure 4: Bottom Layer





REVISION HISTORY

Revision #	Revision Date	Description	Pages Updated
1.0	1/5/2011	Initial Release	-
	7/9/2021	Updated the Description section and Features section	1
1.1		Removed package dimensions in inches from the EV2678EG-00A Evaluation Board section; updated the IC part number from "MP2678EG-104" to "MP2678EG" Updated the Quick Start Guide section; labeled the equation	2
1.1		as "Equation 1" Grammatical, formatting, and clerical updates; updated figure titles; updated pagination; updated EVB part number from "EV2678EG-104-00A" to "EV2678EG-00A"; updated IC part number from "MP2678EG-104" to "MP2678"	All

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